Status of the LHCb Experiment LHCC open session 24 November 2004

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Contents

- I) Experimental Area
- II) Sub-detector systems
 - 1) Magnet
 - 2) Beam Pipe
 - 3) VELO
 - 4) Tracking System (Si Tracker and Outer Tracker)
 - 5) RICH System
 - 6) Calorimeter System
 - 7) Muon System
- III) Trigger
- IV) Computing
- V) Coming Installation
- VI) Conclusions

I) Experimental Area



II) Status of Subsystems





Completed and successfully switched on!



Al normal conductive coil 2×25 t

Power 4.2MW at 1 T field



B field measurement in the box along the HPD plane



RICH-2 photon detector shielding box placed at right position No problem for the HPD operation Agree within a few Gauss with the simulation.

B at various points at the cryogenic plant given to machine group

Commissioning work will continue and improvement will be made for

- •better adjustment of the incoming water temperature control
- •more cooling power for the summer operation

A field map measurement is planned for the coming period, but no firm schedule can be made due to the limited power availability at CERN over the winter.

The final field map must be measured after all the metallic structures around the magnet are installed \rightarrow end of 2005.

2) Beam pipe

•completed by industry

- •ready for fabrication at CERN
- •being fabricated by industry
- •design being finalised

VELO vacuum tank exit window





VELO window



25 mrad Be pipe



Al bellows and flanges



Al bellow and flange



vacuum tank stand and support frame



secondary vacuum rf-box



stress test of rectangular bellows



final sensor, hybrid and readout chip (Beetle) all tested



pre-production n-on-n 200 μm



final hybrid





delivery of pre-production sensors delayed by 3 months 12 both 200 and 300 µm sensors measured \rightarrow decision in January 2005



Outer Tracker

- i.e. assembly of
- 56,000 straws
- 620 panels
- 185 F and 124 S Modules





Module production

- -Krakow: all the panels produced
- -Heidelberg: 60 F modules to be produced
 - 17 produced 1 rejected (first one) 5 days/module
- -NIKHEF: 125 F modules to be produced 30 produced 1 rejected (first one) <3 days/module
- -Warsaw: 124 S modules to be produced 28 produced 2 not gas tight and to be repaired 4.5 days/module

F module production OK S module production OK but tight.

OT front-end electronics





OTIS 1.2 (TDC chip) being tested and works well so far. Engineering run summer next year.



Silicon Tracker



2+2 Si layers $x - u \Leftrightarrow 30 \text{ cm} \Leftrightarrow v - x$

thickness: 500 μm last def strip pitch: 183 μm so called CMS-OB2 from HPK ~1000 sensors being ordered (problem with the production priority)

Inner Tracker ×t 4 125.6 three stations x - u - v - x/station thickness: 300 µm for up and down 400 µm for left and right 198 µm strip pitch: ~ 500 sensors ordered in June 2004 first delivery December 2004 last delivery Autumn 2005

Both readout by the Beetle chip

Trigger Tracker

4 sensors

3 sensors + 39 cm Kapton cable





3 sensors + 39 cm Kapton cable





Integration of TT being finalised

Inner Tracker

IT detector box sits in the middle of the acceptance → minimizing material is crucial



IT and OT can be moved independently of each other

EDR for IT and TT planned for December 2004.¹⁸



Photon detector: Hybrid Photo Diode

RICH2 mechanics





gas enclosure and spherical mirror support

mounting of the front window

RICH1 mechanics

Engineering Design Report completed HPD shielding box ordered Schedule is tight \rightarrow extra manpower has been injected ²⁰

HPD

6 preproduction HPD's have just been tested in beam.







Remaining issues before the HPD mass production

Technical problems with the sensor processing, never had before. Compared with prototype Si sensors:

1) introducing SiO₂ passivation (front side)

photo-resist peels off (metallography)

no bump-solder deposit possible

 \rightarrow Photo-resist sticks with an additional Ti/W coating

2) change of the Al sputtering machine at sub-contractor (back side) back side Al peels off (quality control?) no grounding possible

 \rightarrow Sputtering redone at the bonding factory works fine

We believe that solutions are found

A couple of months delay has been introduced: as soon as the production starts, work out the overall plan—early next year.

6) Calorimeter System

Scintillator-Pad-Detector, Preshower Detector, EM-Calorimeter and H-Calorimeter



23

Preshower-SPD: more than 50% of modules completed (outer region)





PS supermodules



Ecal: 100% completed and being tested with the cosmic rays at CERN



Light output variation between different modules is better than 8%.

Hcal: 96% completed and being tested with ¹³⁷Cs at CERN



r.m.s. of light output from different scintillators in one module is only 4.7% in average.

support structures have been designed, constructed and arriving



Calorimeter front-end electronics

Front-end cards for ECAL/HCAL and SPD/Preshower using antifuse FPGA's have been fully prototyped and debugged.





However, recently reprogrammable FPGA's which can be used in radiation environment have become available → introduces 2 to 3 months delay but large gain in flexibility (details will be reported in January)

7) Muon System

five stations with a pointing pad geometry in four regions



Chamber production in five sites:



10% milestone reached with 7.5 month delay

Enough chambers will be ready to start installation in 01.06 however not possible to complete by end 06 with current plan main problem is manpower for production and testing

By March 2005, we should have enough experience in all sites to make a firm prediction:

→ a scenario ensuring physics in 2007 will be worked out



Muon readout chain

FE-boards

Chambers

Carioca chip: amplifier discriminator DIALOG chip: logical OR of the 2 double-gaps

LVDS links of ~12m length

Racks on the sides of the muon system

Intermediate boards

Required in some regions where the logical channels

go across chambers.

ODE-boards

SYNC chip containing the L0-pipeline and time adjustment



Optical links of ~100m length (with an intermediate patch panel on the balconies behind M5)

Electronics barracks

Tell1, originally developed for VELO now also adopted by TT, IT, OT, Calorimeters, L0 trigger and Muon



three types of chips from the engineering run are now being evaluated.



III) Trigger

Level-0

Input rate = 40 MHz bunch crossing \rightarrow 1 MHz accept High $p_{\rm T}$ h, e, γ , π^0 , μ \rightarrow L0 decision pile-up information

custom made electronics (Calo, Muon, Pile-up, L0 Decision Unit)

Completing the prototype validation

Calorimeter Trigger; Production Readiness Review 2Q/2005

Muon Trigger; PRR 4Q/2005 Pile-up ; PRR 4Q/2005 L0 Decision Unit; PRR Q4/2005



Muon processor card

Level-1

Input rate = 1 MHz Level-0 accept \rightarrow 40 kHz accept $p_{\rm T}$ of 2 tracks with large impact parameters single lepton with large IP and $p_{\rm T}$ single γ with large $p_{\rm T}$ dimuon

CPU farm common with High Level Trigger (VELO, TT, L0)

Improving the selection algorithms

efficiency on offline selected events

$$B^{0} \rightarrow \pi^{+} \pi^{-}$$
$$B_{s} \rightarrow D_{s} K$$
$$B_{s} \rightarrow J/\psi \phi$$

 $63\%(TDR) \rightarrow 81\%$ $63\%(TDR) \rightarrow 81\%$ $71\%(TDR) \rightarrow 87\%$

speed

with 1 GHz Pentium III

8.3 ms(TDR) \rightarrow 5 ms^{*)}

*) this is already within the allocated time budget with 2007 CPU

High Level Trigger

Input rate = 40 kHz Level-1 accept \rightarrow event store rate selections using all the detector information

CPU farm (all the detector)

Baseline selection

Exclusive B decay reconstruction modes e.g. given in TDR work in progress, trigger rate is a few Hz for each decay mode,

i.e. 200Hz appears to be sufficient for them.

Recent development

We realised that J/ψ and D^0 are important for detector calibration, a lesson from the Tevatron experiments

 $J/\psi \rightarrow \mu^+\mu^-$ (well defined mass with two muons) easy channel to trigger and reconstruct

 \rightarrow dimuon trigger without impact parameter cuts

-Calibration of the absolute momentum (alignment, B field,

dE/dx, etc.) then control it with $\psi(2S)$, $\Upsilon(1-3S)$ and Z⁰

-Vertex resolution (prompt J/ψ)

-Control of the proper-time calibration $(B^+ \rightarrow J/\psi \pi^+, B^0 \rightarrow J/\psi K^{*0})$ Signal rate

 $L0 \times L1 \times Offline reconstruction = 170 \text{ Hz of } J/\psi \text{ signal}$ Trigger rate if

 $L0 \times L1 \times HLT (m_{u^+u^-} > J/\psi \text{ mass}) = 600 \text{ Hz}$

 $D^0 \rightarrow K^-\pi^+$ (well defined mass with two hadrons) a good source for absolute momentum and PID calibration and calibration of detector simulation for lifetime measurements.

Signal rate

L0×L1×Offline reconstruction ≈ 50 Hz of D^{*+} $\rightarrow \pi^+ D^0(K^-\pi^+)$ Trigger rate 36

 $L0 \times L1 \times HLT(D^{*+} \rightarrow \pi^+ D^0 \rightarrow h^+h^-) = 300 \text{ Hz}$

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and they also address interesting physics

b-hadron spectroscopy and lifetimes

B_c \rightarrow J/\psi \pi, \Lambda_b \rightarrow J/\psi \Lambda, \Xi_b \rightarrow J/\psi \Lambda K_S etc.

if D<sup>0</sup> is tagged by \pi^+ from D<sup>*+</sup> \rightarrow \pi^+ D<sup>0</sup>

D-D oscillations

CP asymmetry in K<sup>+</sup>K<sup>-</sup> to a 10<sup>-4</sup> level

NB: 50 M D\rightarrowK<sup>+</sup>K<sup>-</sup> might be collected in 10<sup>7</sup>s

(systematics is of course the issue)
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Another interesting possibility is inclusive μ trigger with p_T and impact parameter cuts triggering on b $\rightarrow \mu X$ simple trigger and other b-hadron unbiased may be useful for the initial phase...



Where do we stand?

Well motivated exclusive final state trigger	
B exclusive decays for TDR physics	200 Hz
dimuon ($m_{\mu^+\mu^-} \gtrsim J/\psi$ mass)	600 Hz
$D^* \rightarrow D^0 \pi$	300 Hz
An additional trigger for unbiased b sample	
high $p_{\rm T}$, high IP μ trigger	up to $\sim 2 \text{ kHz}$

A sensible combination must be made to maximise physics within the available computing resources.

Desirable to have a flexible computing model which is scalable and able to accommodate different scenarios.



Testbed setup with two complete subfarms (2×23 Processors)





Ethernet Cabling in the barracks starts end 11.04 ~3000 connections, ~300 patch panels Optical Fibers from computer room to barracks will be done in 01.05

Experiment Control System software status

Configuration Database

-TFC system implemented including connectivity and paths -navigation and visualization tools developed

PC farm monitoring & control -monitoring of PC information within PVSS implemented -control of running processes

-first prototype will be available at CERN soon.

Offline Computing

Software framework, GAUDI, based applications are in place for detector simulation event reconstruction event analysis

however, consolidation with the ongoing development needed.

Event store is done by the LCG product, POOL

Strategy development for detector alignment and calibration started

Data Challenge 04

Phase-1 (MC production and reconstruction) completed close collaboration with the LCG deployment team finally resulted in reaching to a stage where 3500 jobs concurrently running in LCG sites with an average of 61% efficiency

-due to a problem with the random number seed, only 16'777'216 unique events (24 bits). Now this is fixed and start some new generation-

Phase-2 (Fast event selection) just started delayed due to adaptation of LHCb software to LCG and SRM (LCG software for mass storage access) not being ready

Evolution of the LHCb computing model

At the time of "Hoffmann review", we thought

- -bb inclusive MC events were important to understand background
- -for the real data, only events with exclusive B decay final states should be recorded
- \rightarrow MC sample dominating the computing need

However now, we think

- -no way to generate enough statistics to understand background in a generic way
- -MC events are important to understand signal acceptance and specific background, as before
- -real data must be used as much as possible to understand all the systematic effects and to tune the simulation
- \rightarrow much less bb inclusive MC events needed
- \rightarrow much more data such as J/ ψ and D⁰ needed

CPU and storage requirements would change → consequence is being studied essential for the Computing TDR in 2005

IV) Coming Installation

•Electromagnetic Calorimeter January '05 •Support •modules installation February '05 •Hadron Calorimeter •Support February '05 •modules installation March '05 •**RICH 2** August '05 •Preshower & SPD, lead & super-modules December '06 •Outer Tracker, structure and detector November '05 •Vertex Locator November '05 •Vacuum vessel October '06 •Sensors •**RICH** 1 •Shielding box April '05 •Gas enclosure November '05 •Inner Tracker •First box February '06 •Remaining sensors June '06 •Trigger Tracker June '06 Muon chamber installation January '06 •Beam pipe installation $\bullet U\overline{X}1\overline{\&}2$ April '06 May '06 •UX3&4 •Bake out & commissioning August '06

V) Conclusions

Good achievement made for the construction of many subsystems:

- -Beam pipe, Magnet, RICH2 mechanics, Calorimeter system, and Online system are progressing well.
- -Outer Tracker, RICH1 mechanics, HPD and VELO are also making good progress, however with tight planning.
- -We are looking forward to seeing the production of the Trigger Tracker and Inner Tracker start as planned. A major concern is how to solve the conflict with CMS on the delivery schedule for the TT sensors.
- -Production of the Muon chambers is facing a substantial delay. Necessary action will be decided in March 2005 when we expect to have all the information needed.
- -Need on computing resource is evolving and its effect on computing model is being investigated.

